

# 7N65

**Power MOSFET**

## 7.4A, 650V N-CHANNEL POWER MOSFET

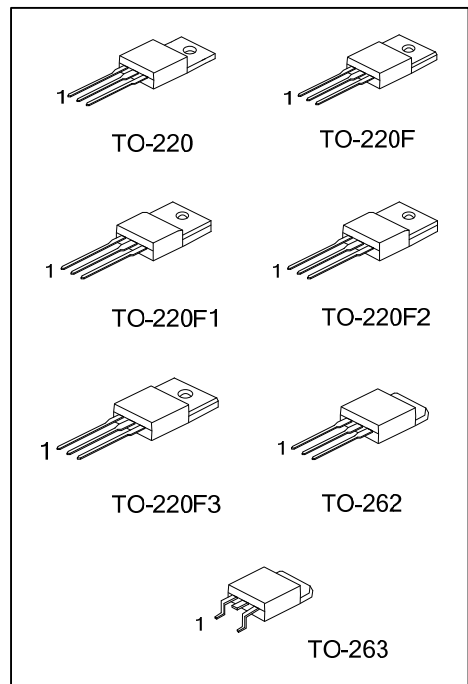
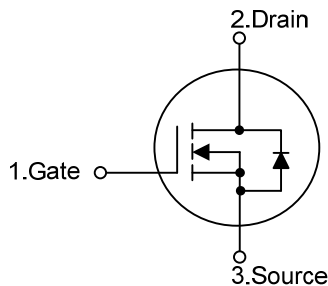
■ DESCRIPTION

The **7N65** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in switching power supplies and adaptors.

■ FEATURES

- \*  $R_{DS(ON)} < 1.2\Omega @ V_{GS} = 10V$
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

■ SYMBOL



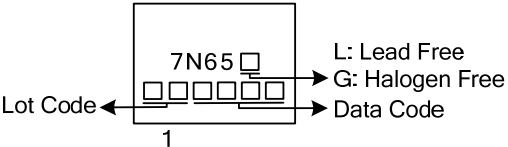
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
7N65L-TA3-T	7N65G-TA3-T	TO-220	G	D	S	Tube
7N65L-TF3-T	7N65G-TF3-T	TO-220F	G	D	S	Tube
7N65L-TF1-T	7N65G-TF1-T	TO-220F1	G	D	S	Tube
7N65L-TF2-T	7N65G-TF2-T	TO-220F2	G	D	S	Tube
7N65L-TF3T-T	7N65G-TF3T-T	TO-220F3	G	D	S	Tube
7N65L-T2Q-T	7N65G-T2Q-T	TO-262	G	D	S	Tube
7N65L-TQ2-T	7N65G-TQ2-T	TO-263	G	D	S	Tube
7N65L-TQ2-R	7N65G-TQ2-R	TO-263	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>(1) Packing Type (2) Package Type (3) Lead Free</p>	<p>(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF1: TO-220F1, TF3: TO-220F TF2: TO-220F2, TF3T: TO-220F3, T2Q: TO-262 TQ2: TO-263 (3) L: Lead Free, G: Halogen Free</p>
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■ MARKING INFORMATION

PACKAGE	MARKING
TO-220 TO-220F TO-220F1 TO-220F2 TO-220F3 TO-262 TO-263	

■ ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	650	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Avalanche Current (Note 2)		$I_{AR}$	7.4	A
Drain Current	Continuous	$I_D$	7.4	A
	Pulsed (Note 2)	$I_{DM}$	29.6	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	530	mJ
	Repetitive (Note 2)	$E_{AR}$	14.2	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation	TO-220/TO-262/TO-263	$P_D$	142	W
	TO-220F/TO-220F1		48	
	TO-220F3		50	
	TO-220F2			
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3.  $L = 19.5\text{mH}$ ,  $I_{AS} = 7.4\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 7.4\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

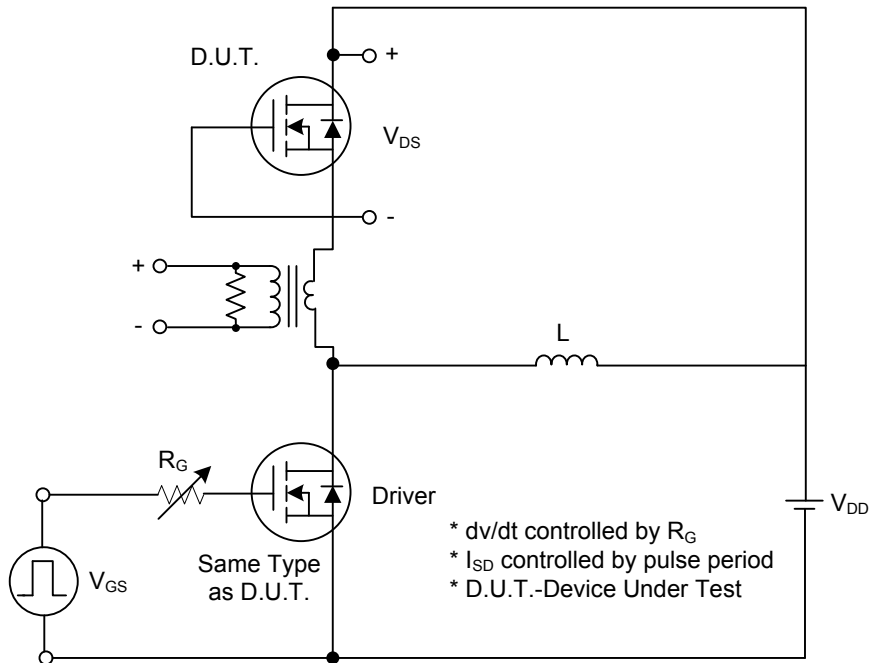
PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		$\theta_{JA}$	62.5	$^\circ\text{C}/\text{W}$
Junction to Case	TO-220/TO-262/TO-263	$\theta_{JC}$	0.88	$^\circ\text{C}/\text{W}$
	TO-220F/TO-220F1		2.6	
	TO-220F3			
	TO-220F2		2.5	

■ ELECTRICAL CHARACTERISTICS (T<sub>C</sub>=25°C, unless otherwise specified)

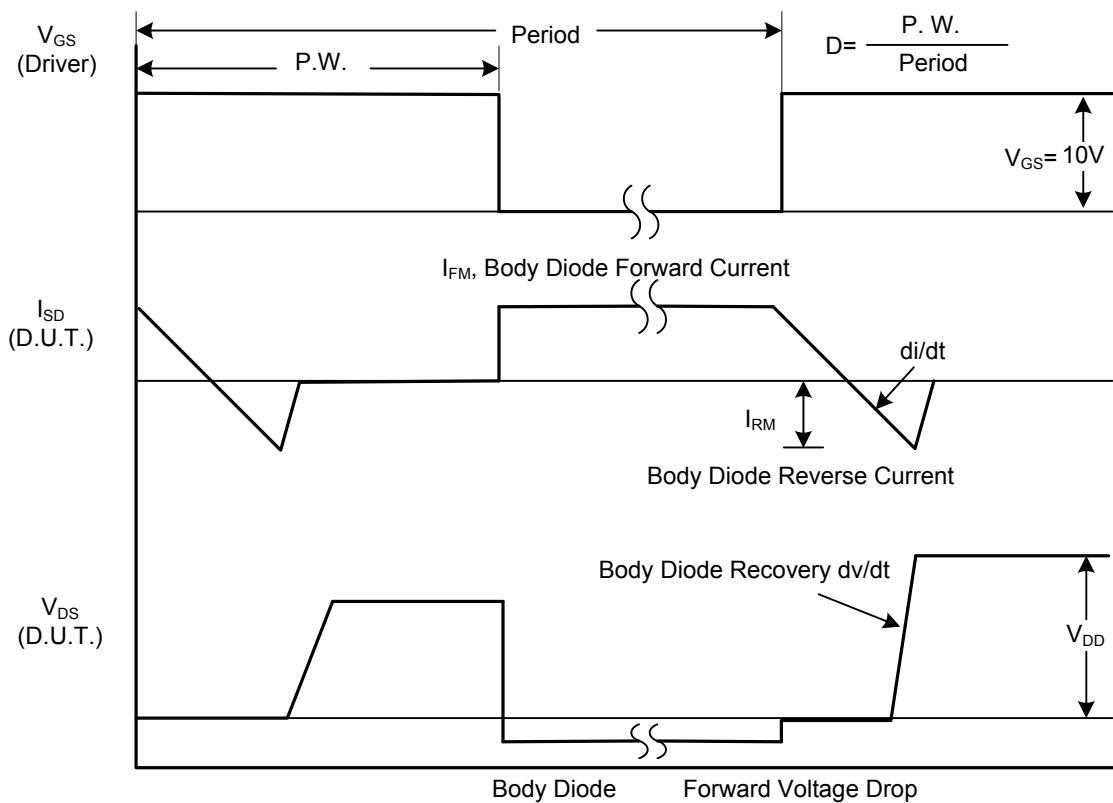
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	650			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> = 650V, V <sub>GS</sub> = 0V			1	μA
Gate- Source Leakage Current	Forward	I <sub>GSS</sub>			100	nA
	Reverse				-100	nA
Breakdown Voltage Temperature Coefficient	ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	I <sub>D</sub> =250μA, Referenced to 25°C		0.67		V/°C
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2.0		4.0	V
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 3.7A		0.94	1.2	Ω
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0 MHz		1210	1400	pF
Output Capacitance	C <sub>OSS</sub>			140	180	pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			40	50	pF
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> =325V, I <sub>D</sub> =7.4A, R <sub>G</sub> =25Ω (Note 1, 2)		50	70	ns
Turn-On Rise Time	t <sub>R</sub>			150	180	ns
Turn-Off Delay Time	t <sub>D(OFF)</sub>			380	410	ns
Turn-Off Fall Time	t <sub>F</sub>			180	220	ns
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge	Q <sub>G</sub>	V <sub>DS</sub> =520V, I <sub>D</sub> =7.4A, V <sub>GS</sub> =10 V (Note 1, 2)		29	38	nC
Gate-Source Charge	Q <sub>GS</sub>			9		nC
Gate-Drain Charge	Q <sub>GD</sub>			19		nC
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 7.4 A			1.4	V
Maximum Continuous Drain-Source Diode Forward Current	I <sub>S</sub>				7.4	A
Maximum Pulsed Drain-Source Diode Forward Current	I <sub>SM</sub>				29.6	A
Reverse Recovery Time	t <sub>rr</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 7.4 A,		320		ns
Reverse Recovery Charge	Q <sub>RR</sub>	dI <sub>F</sub> / dt = 100A/μs (Note 1)		2.4		μC

Notes: 1. Pulse Test: Pulse width≤300μs, Duty cycle≤2%  
2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

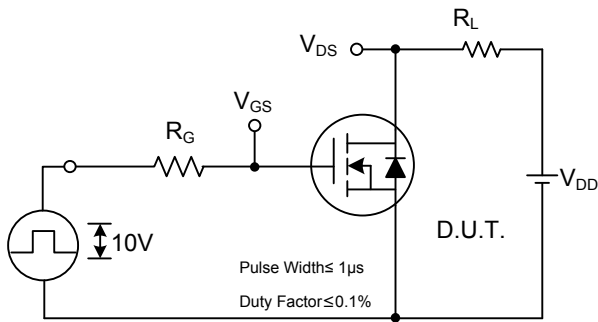


Peak Diode Recovery  $dv/dt$  Test Circuit

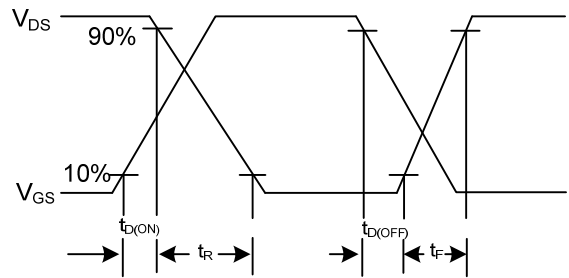


Peak Diode Recovery  $dv/dt$  Waveforms

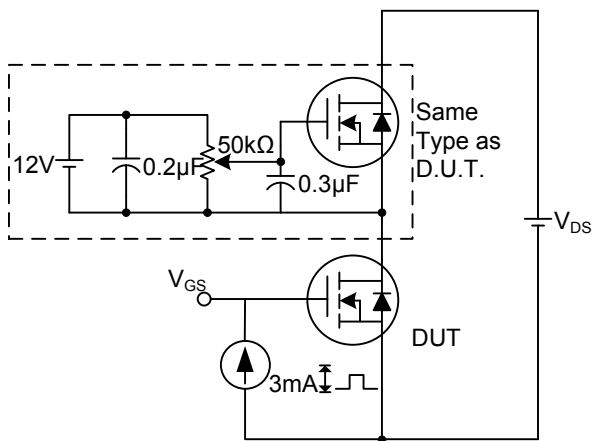
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



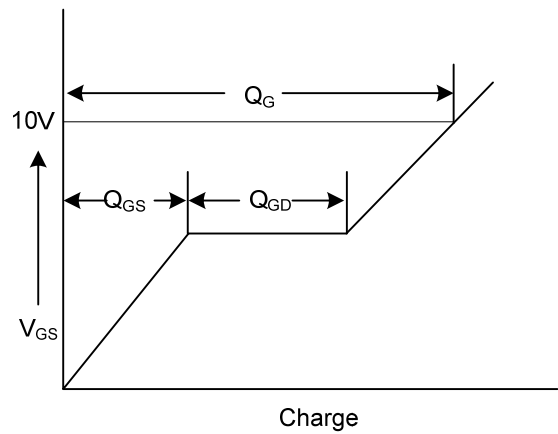
Switching Test Circuit



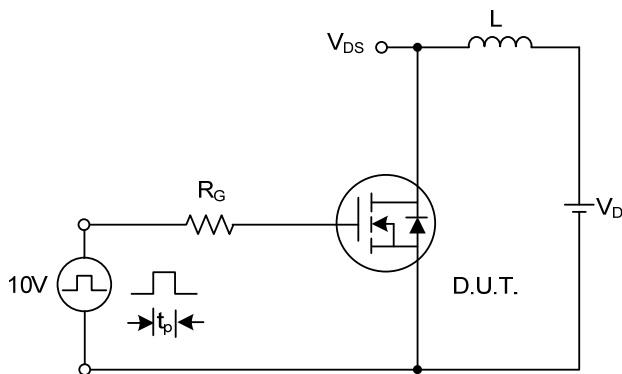
Switching Waveforms



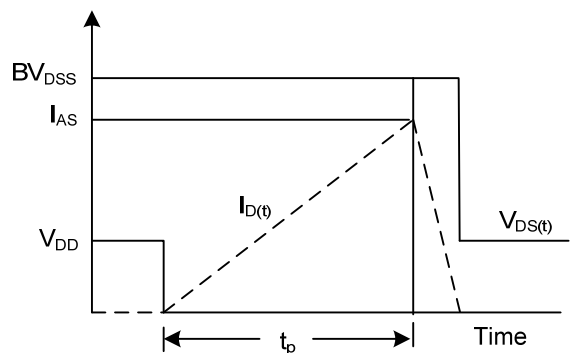
Gate Charge Test Circuit



Gate Charge Waveform



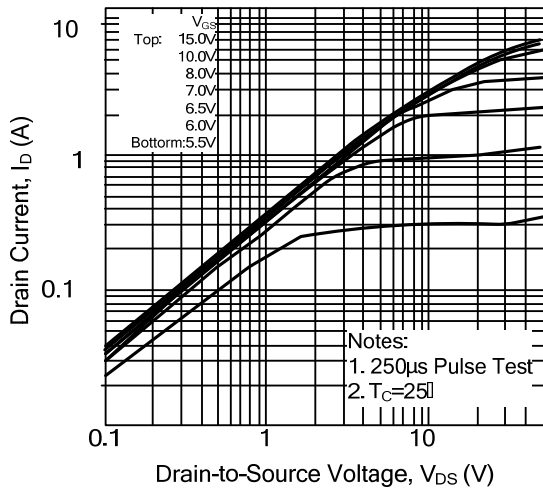
Unclamped Inductive Switching Test Circuit



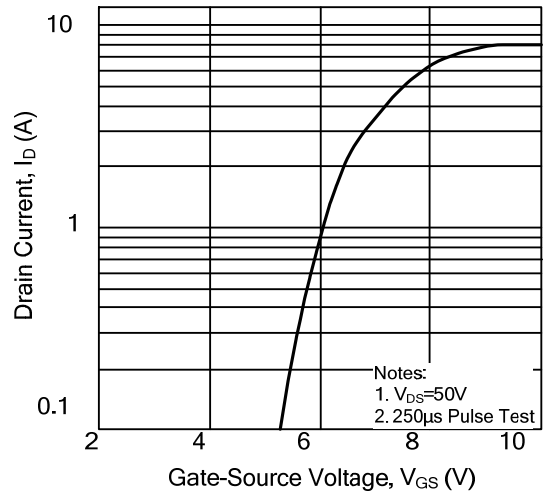
Unclamped Inductive Switching Waveforms

## TYPICAL CHARACTERISTICS

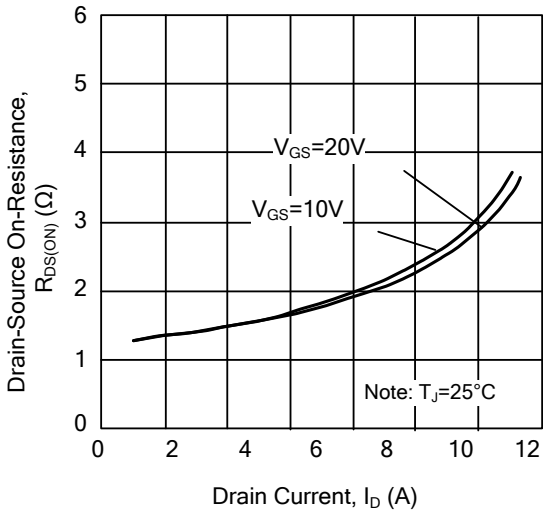
### On-State Characteristics



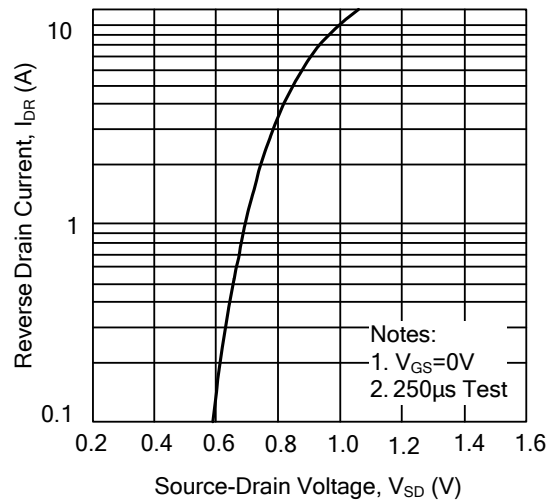
### Transfer Characteristics



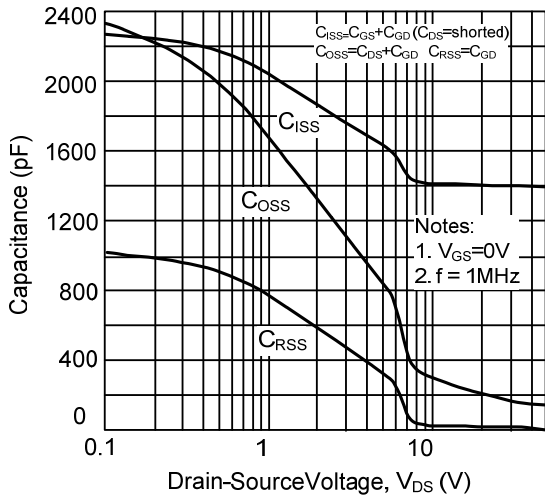
### On-Resistance Variation vs. Drain Current and Gate Voltage



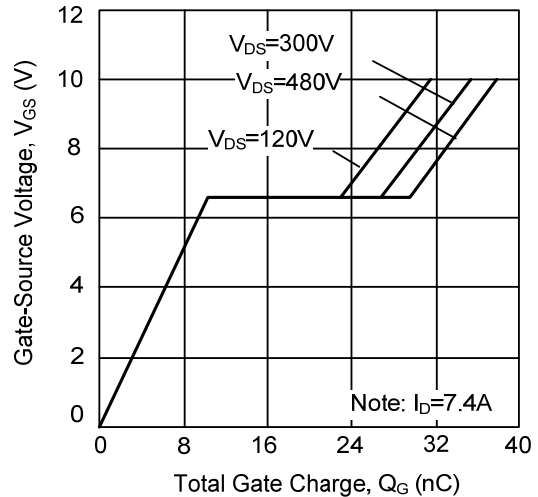
### On State Current vs. Allowable Case Temperature



### Capacitance Characteristics (Non-Repetitive)



### Gate Charge Characteristics



■ TYPICAL CHARACTERISTICS(Cont.)

